



IEEE 24th International Conference
of Young Professionals in Electron
Devices and Materials

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Erlagol, Altai Republic, Russia

DIPLOMA

THIRD PLACE

THIS CONFIRMS THAT

Snezhana Mantsurova

PRESENTED A REPORT ENTITLED:

«Temperature Influence on the Si(111) Surface Relief Evolution during Au Deposition»

AT THE SECTION

Semiconductor Physics and Technology

Chair of
EDM 2023

Sergey
Brovanov